

IRGP30B120KD-E

International
IOR Rectifier

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	Fig.
V _{(BR)CES}	Collector-to-Emitter Breakdown Voltage	1200			V	V _{GE} = 0V, I _C = 250 μA	
ΔV _{(BR)CES} / ΔT _J	Temperature Coeff. of Breakdown Voltage		+1.2		V/°C	V _{GE} = 0V, I _C = 1 mA (25 -125 °C)	
V _{CE(on)}	Collector-to-Emitter Saturation Voltage		2.28	2.48	V	I _C = 25A, V _{GE} = 15V	5, 6
			2.46	2.66		I _C = 30A, V _{GE} = 15V	7, 9
			3.43	4.00		I _C = 60A, V _{GE} = 15V	10
			2.74	3.10		I _C = 25A, V _{GE} = 15V, T _J = 125°C	11
			2.98	3.35		I _C = 30A, V _{GE} = 15V, T _J = 125°C	
V _{GE(th)}	Gate Threshold Voltage	4.0	5.0	6.0	V	V _{CE} = V _{GE} , I _C = 250 μA	9,10,11,12
ΔV _{GE(th)} / ΔT _J	Temperature Coeff. of Threshold Voltage		- 1.2		mV/°C	V _{CE} = V _{GE} , I _C = 1 mA (25 -125 °C)	
g _{fe}	Forward Transconductance	14.8	16.9	19.0	S	V _{CE} = 50V, I _C = 25A, PW=80μs	
I _{CES}	Zero Gate Voltage Collector Current			250	μA	V _{GE} = 0V, V _{CE} = 1200V	
			325	675		V _{GE} = 0v, V _{CE} = 1200V, T _J =125°C	
				2000		V _{GE} = 0v, V _{CE} = 1200V, T _J =150°C	
V _{FM}	Diode Forward Voltage Drop		1.76	2.06	V	I _C = 25A	8
			1.86	2.17		I _C = 30A	
			1.87	2.18		I _C = 25A, T _J = 125°C	
			2.01	2.40		I _C = 30A, T _J = 125°C	
I _{GES}	Gate-to-Emitter Leakage Current			±100	nA	V _{GE} = ±20V	

Switching Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	Fig.
Q _g	Total Gate charge (turn-on)		169	254	nC	I _C = 25A	23
Q _{ge}	Gate - Emitter Charge (turn-on)		19	29		V _{CC} =600V	CT 1
Q _{gc}	Gate - Collector Charge (turn-on)		82	123		V _{GE} = 15V	
E _{on}	Turn-On Switching Loss		1066	1250	μJ	I _C = 25A, V _{CC} = 600V	CT 4
E _{off}	Turn-Off Switching Loss		1493	1800		V _{GE} = 15V, R _g = 5Ω, L=200μH	WF1
E _{tot}	Total Switching Loss		2559	3050		T _J = 25°C, Energy losses include tail and diode reverse recovery	WF2
E _{on}	Turn-on Switching Loss		1660	1856	μJ	I _C =25A, V _{CC} =600V	13, 15
E _{off}	Turn-off Switching Loss		2118	2580		V _{GE} = 15V, R _g = 5Ω, L=200μH	CT 4
E _{tot}	Total Switching Loss		3778	4436		T _J = 125°C, Energy losses include tail and diode reverse recovery	WF1 & 2
td(on)	Turn - on delay time		50	65	ns	I _C =25A, V _{CC} =600V	14, 16
tr	Rise time		25	35		V _{GE} = 15V, R _g = 5Ω, L=200μH	CT 4
td(off)	Turn - off delay time		210	230		T _J = 125°C,	WF1
tf	Fall time		60	75			WF2
C _{ies}	Input Capacitance		2200		pF	V _{GE} = 0V	22
C _{oes}	Output Capacitance		210			V _{CC} = 30V	
C _{res}	Reverse Transfer Capacitance		85			f = 1.0 MHz	
RBSOA	Reverse bias safe operating area	FULL SQUARE				T _J =150°C, I _C = 120A V _{CC} = 1000V, V _P = 1200V R _g = 5Ω, V _{GE} = +15V to 0 V	4 CT 2
SCSOA	Short Circuit Safe Operating Area	10	----	----	μs	T _J = 150°C V _{CC} = 900V, V _P = 1200V R _g = 5Ω, V _{GE} = +15V to 0 V	CT 3 WF4
E _{rec}	Reverse recovery energy of the diode		1820	2400	μJ	T _J = 125°C	17,18,19
trr	Diode Reverse recovery time		300		ns	V _{CC} = 600V, I _C = 25A	20, 21
I _{rr}	Peak Reverse Recovery Current		34	38	A	V _{GE} = 15V, R _g = 5Ω, L=200μH	CT 4, WF3
Le	Internal Emitter Inductance		13		nH	Measured 5 mm from the package.	

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Fig.1 - Maximum DC Collector Current vs. Case Temperature



Fig.2 - Power Dissipation vs. Case Temperature

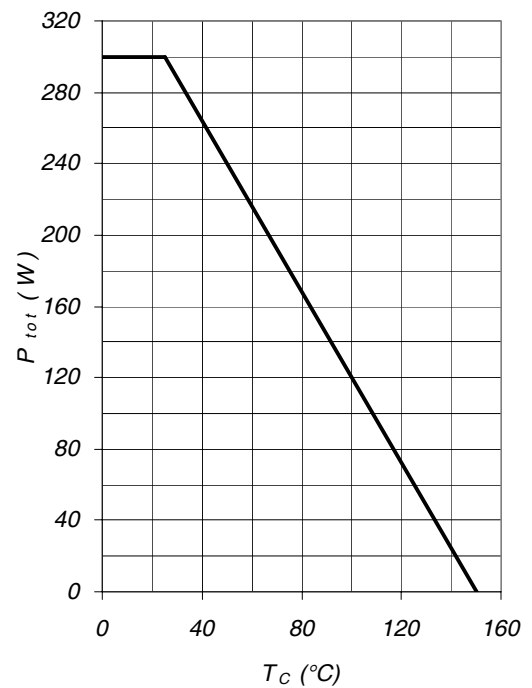


Fig.3 - Forward SOA
 $T_C=25^{\circ}\text{C}$; $T_J \leq 150^{\circ}\text{C}$

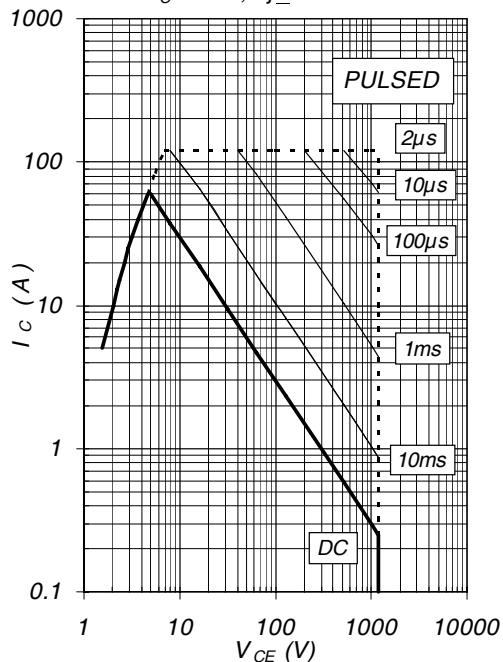


Fig.4 - Reverse Bias SOA
 $T_J = 150^{\circ}\text{C}$, $V_{GE} = 15\text{V}$

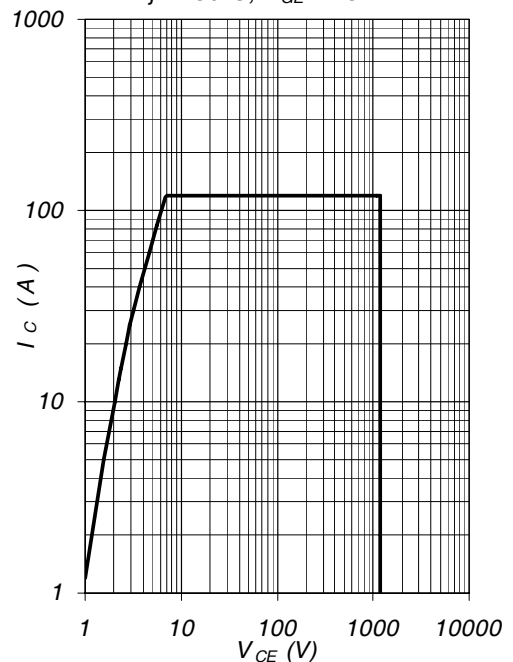


Fig.5 - Typical IGBT Output Characteristics
 $T_j = -40^\circ\text{C}$; $t_p = 300\mu\text{s}$

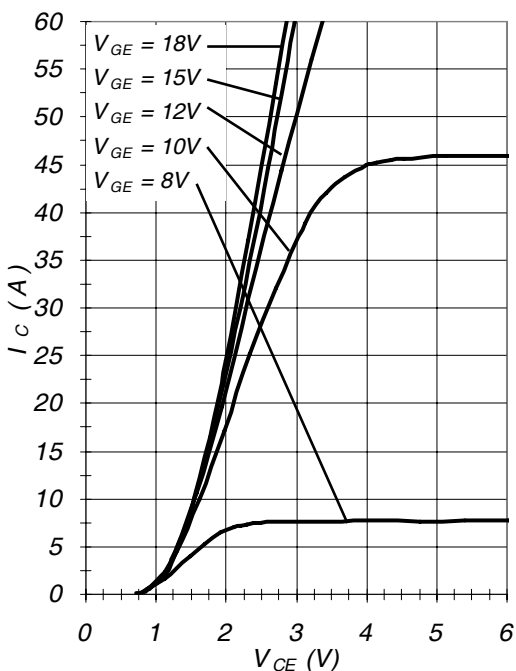


Fig.6 - Typical IGBT Output Characteristics
 $T_j = 25^\circ\text{C}$; $t_p = 300\mu\text{s}$

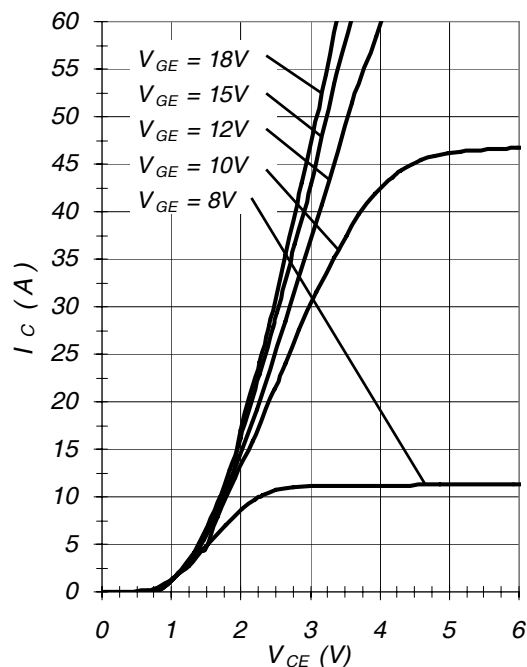


Fig.7 - Typical IGBT Output Characteristics
 $T_j = 125^\circ\text{C}$; $t_p = 300\mu\text{s}$

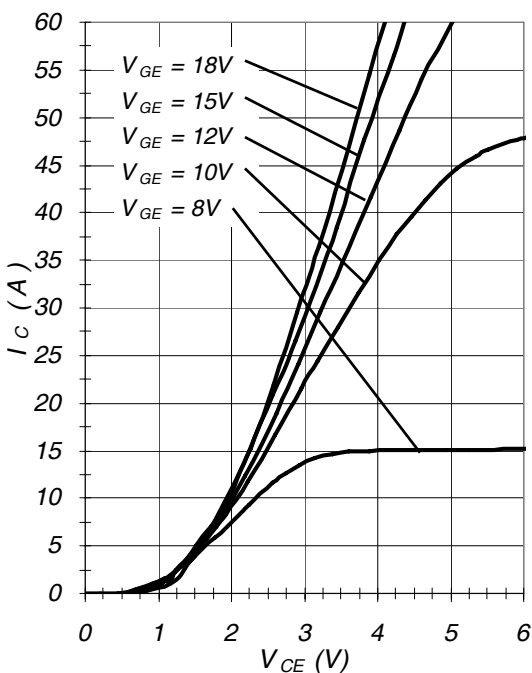
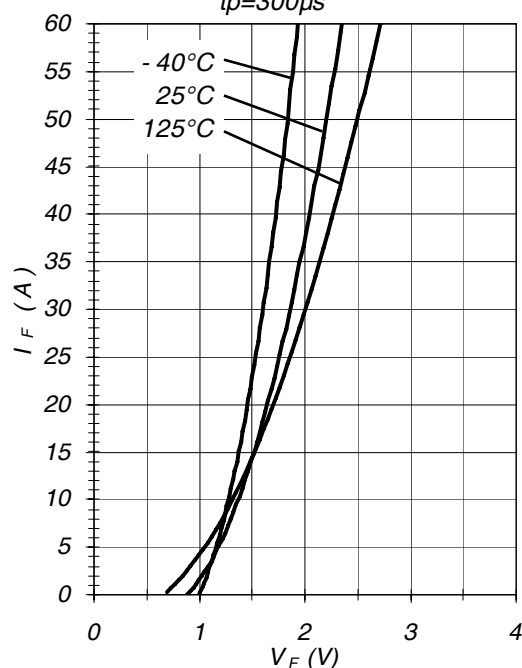


Fig.8 - Typical Diode Forward Characteristic
 $t_p = 300\mu\text{s}$



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Fig.9 - Typical V_{CE} vs V_{GE}
 $T_j = -40^\circ\text{C}$

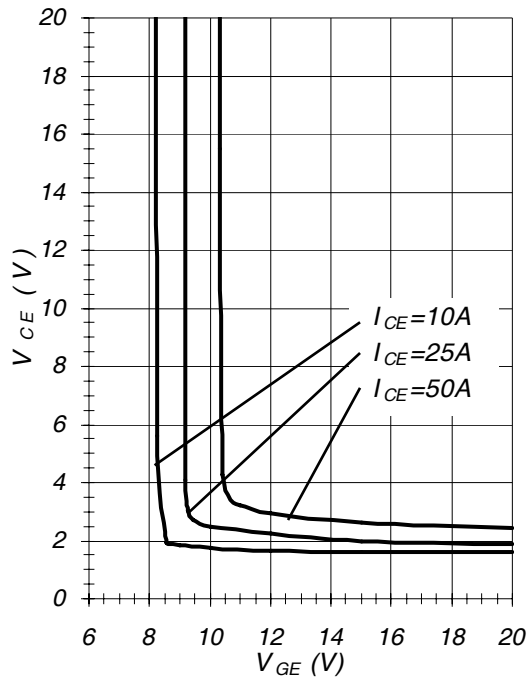


Fig.10 - Typical V_{CE} vs V_{GE}
 $T_j = 25^\circ\text{C}$

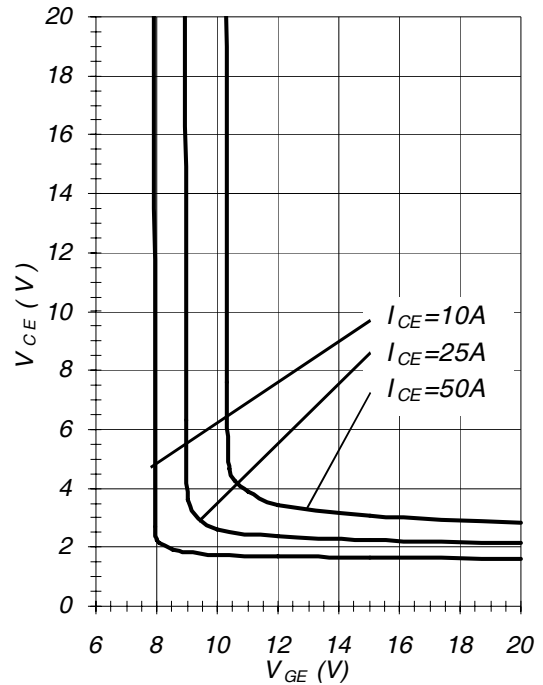


Fig.11 - Typical V_{CE} vs V_{GE}
 $T_j = 125^\circ\text{C}$

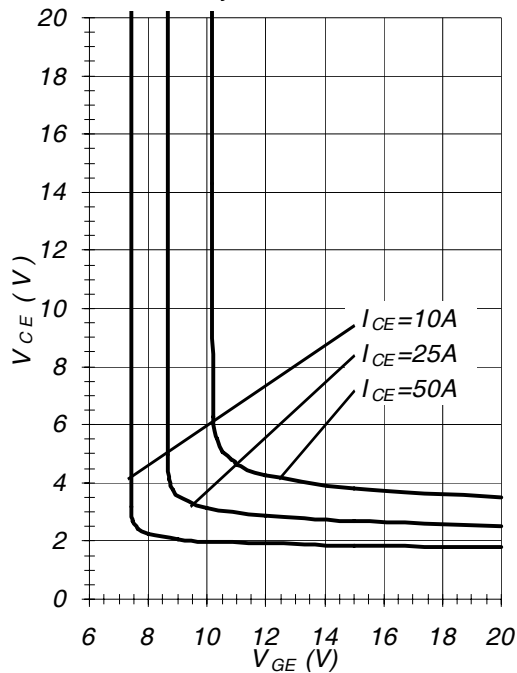
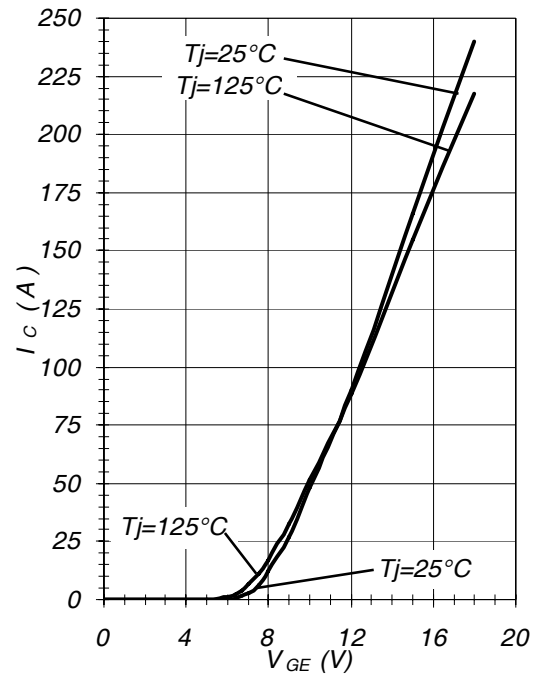


Fig.12 - Typ. Transfer Characteristics
 $V_{CE} = 20\text{V}$; $t_p = 20\mu\text{s}$



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Fig.13 - Typical Energy Loss vs I_C
 $T_j=125^\circ\text{C}$; $L=200\mu\text{H}$; $V_{CE}=600\text{V}$;
 $R_g=22\ \Omega$; $V_{GE}=15\text{V}$

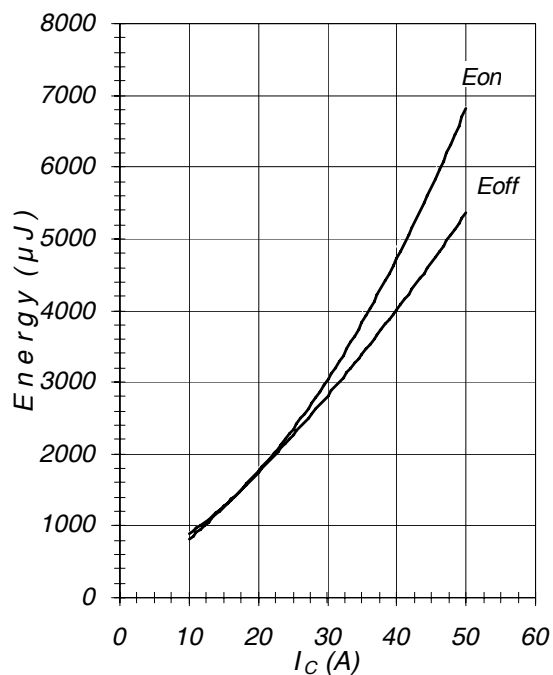


Fig.14 - Typical Switching Time vs I_C
 $T_j=125^\circ\text{C}$; $L=200\mu\text{H}$; $V_{CE}=600\text{V}$;
 $R_g=22\ \Omega$; $V_{GE}=15\text{V}$

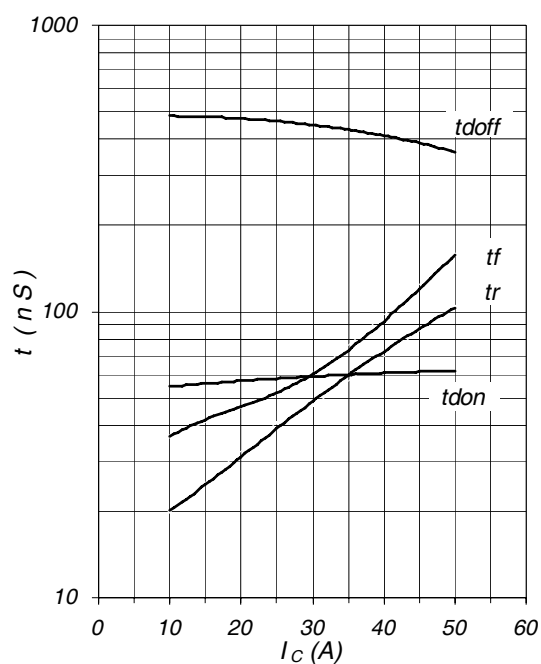


Fig.15 - Typical Energy Loss vs R_g
 $T_j=125^\circ\text{C}$; $L=200\mu\text{H}$; $V_{CE}=600\text{V}$;
 $I_{CE}=25\text{A}$; $V_{GE}=15\text{V}$

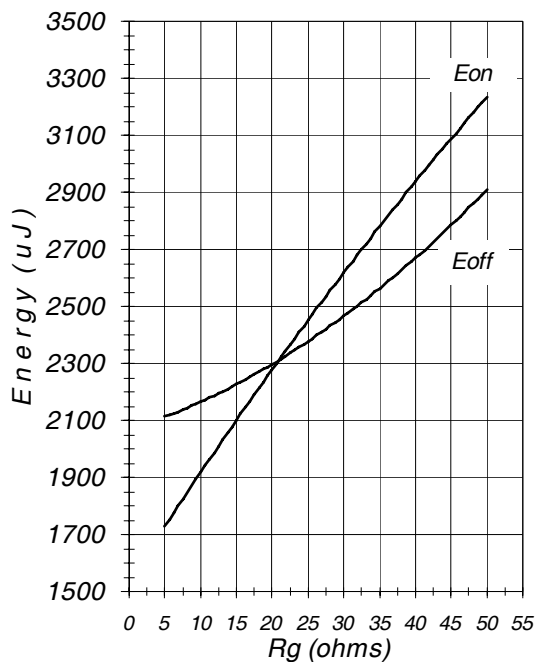
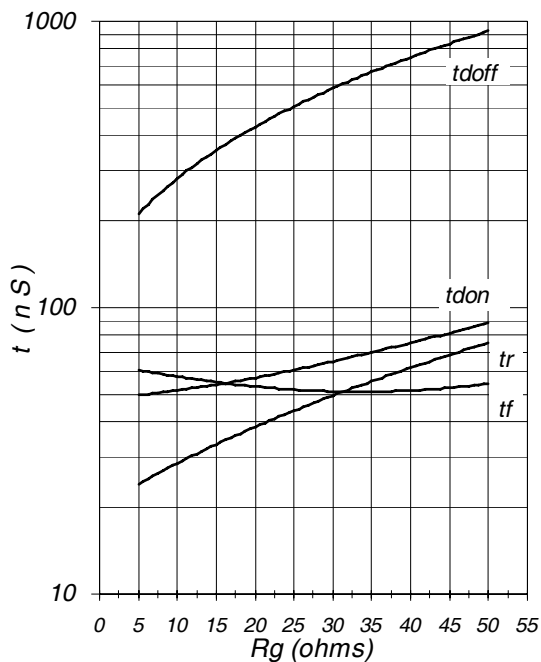


Fig.16 - Typical Switching Time vs R_g
 $T_j=125^\circ\text{C}$; $L=200\mu\text{H}$; $V_{CE}=600\text{V}$;
 $I_{CE}=25\text{A}$; $V_{GE}=15\text{V}$



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Fig.17 - Typical Diode I_{RR} vs I_F
 $T_J=125^\circ\text{C}$

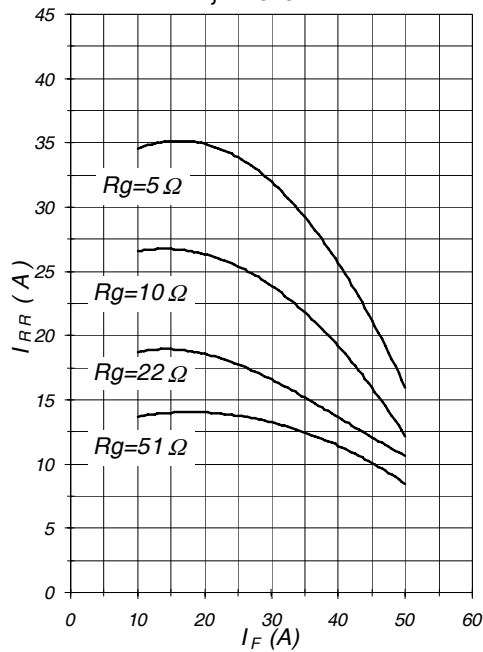


Fig.18 - Typical Diode I_{RR} vs R_g
 $T_J=125^\circ\text{C}; I_F=25\text{A}$

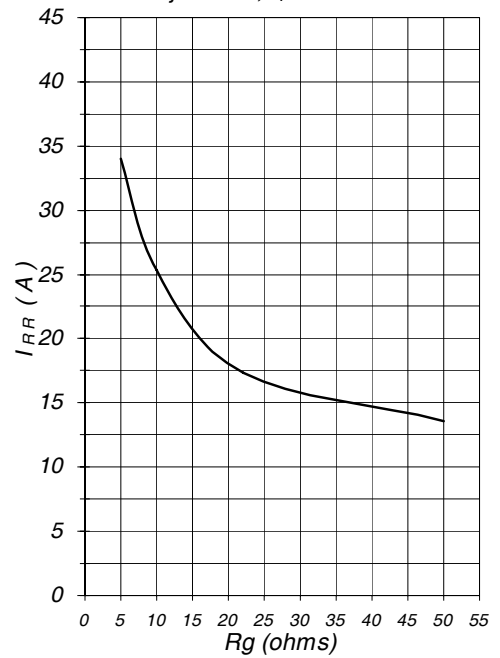


Fig.19 - Typical Diode I_{RR} vs dI_F/dt
 $V_{CC}=600\text{V}; V_{GE}=15\text{V}$
 $I_F=25\text{A}; T_J=125^\circ\text{C}$

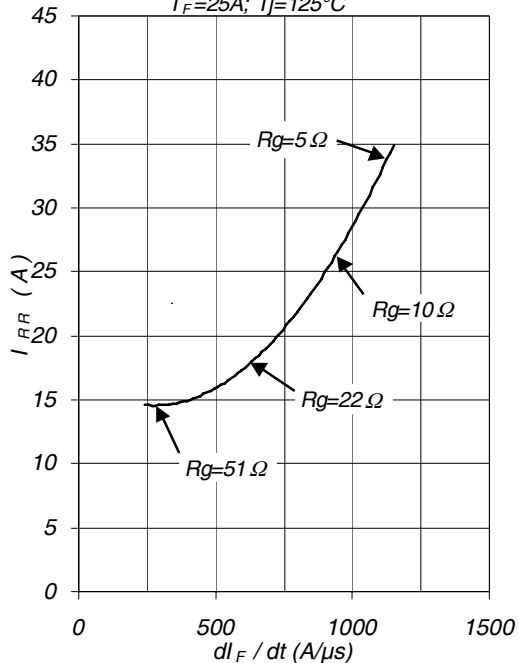


Fig.20 - Typical Diode Q_{RR}
 $V_{CC}=600\text{V}; V_{GE}=15\text{V}; T_J=125^\circ\text{C}$

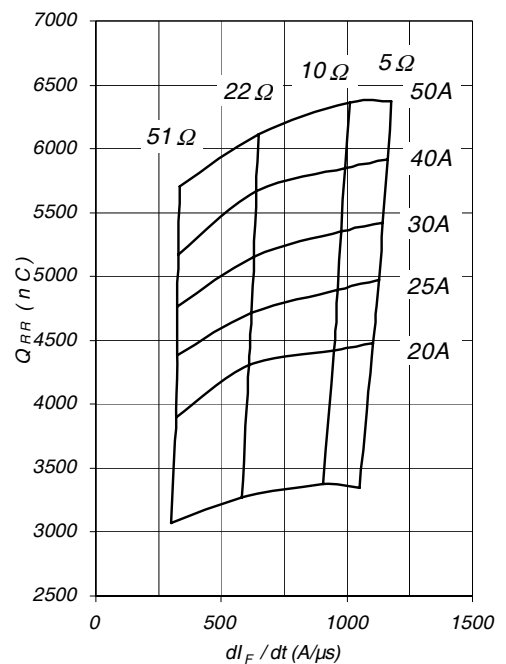


Fig.21 - Typ. Diode E_{rec} vs. I_F
 $T_J=125^{\circ}\text{C}$

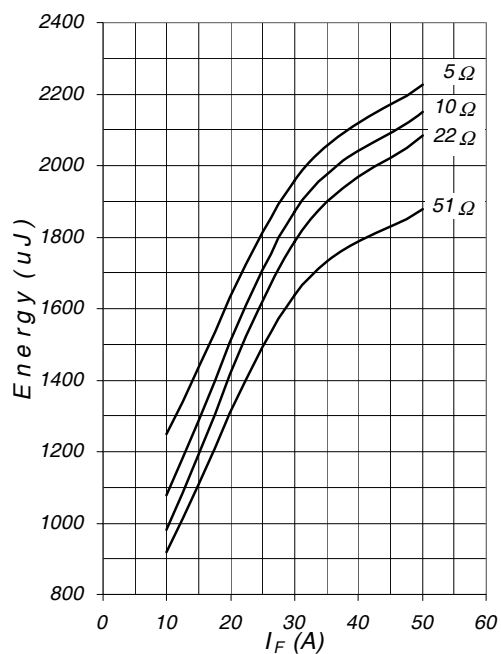


Fig.22 - Typical Capacitance vs V_{CE}
 $V_{GE}=0\text{V}$; $f=1\text{MHz}$

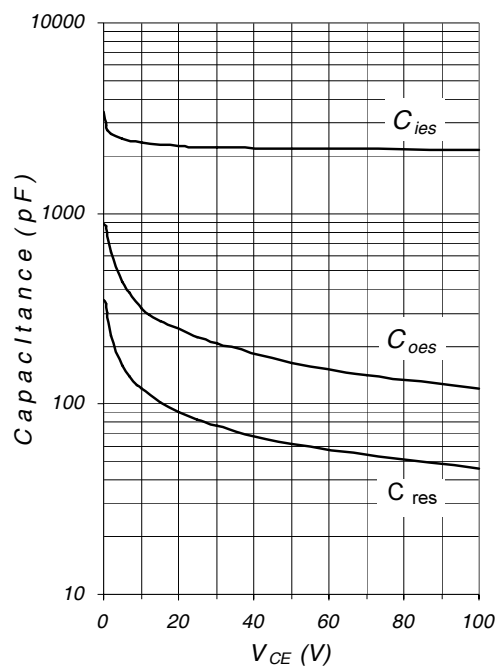


Fig.23 - Typ. Gate Charge vs. V_{GE}
 $I_C=25\text{A}$; $L=600\mu\text{H}$

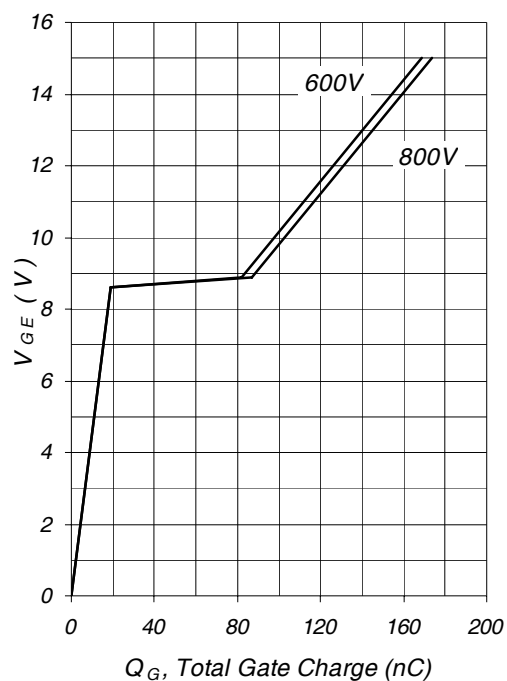
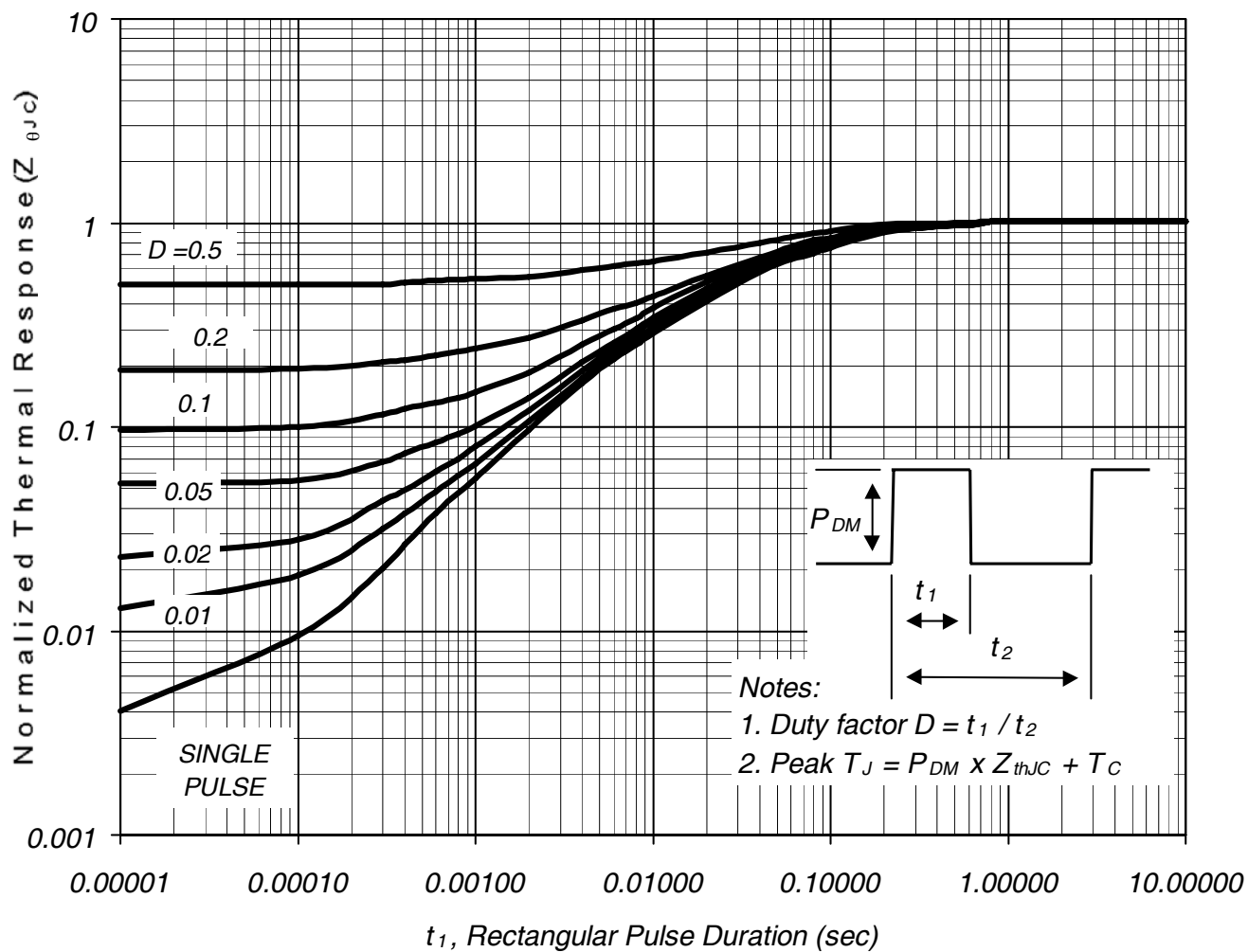


Fig.24 - Normalized Transient Thermal Impedance, Junction-to-Case



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Fig. CT.1 - Gate Charge Circuit (turn-off)

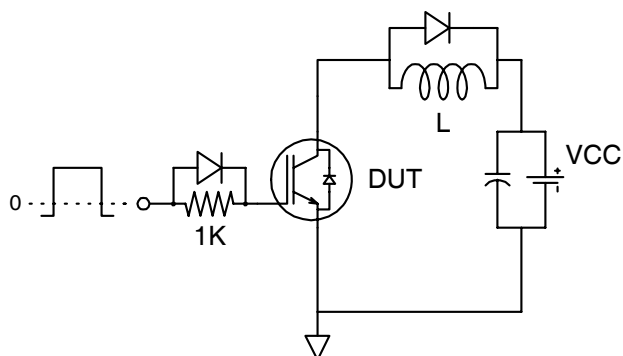


Fig. CT.2 - RBSOA Circuit

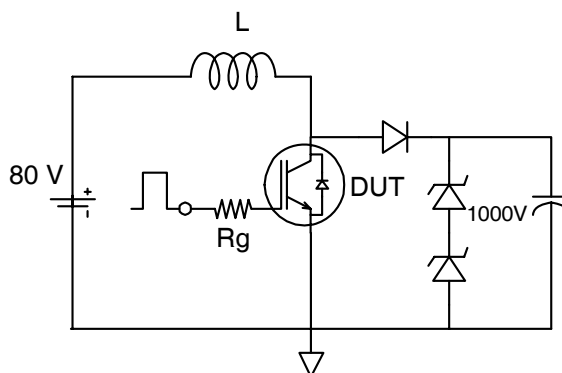


Fig. CT.3 - S.C. SOA Circuit

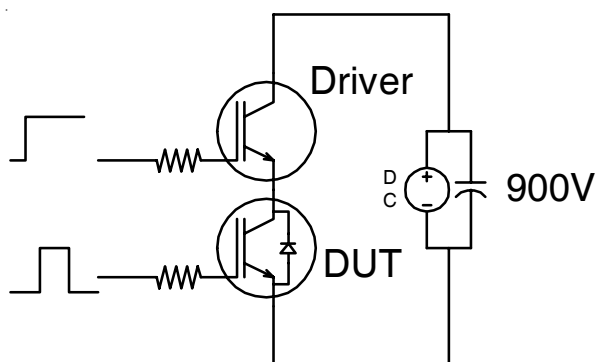


Fig. CT.4 - Switching Loss Circuit

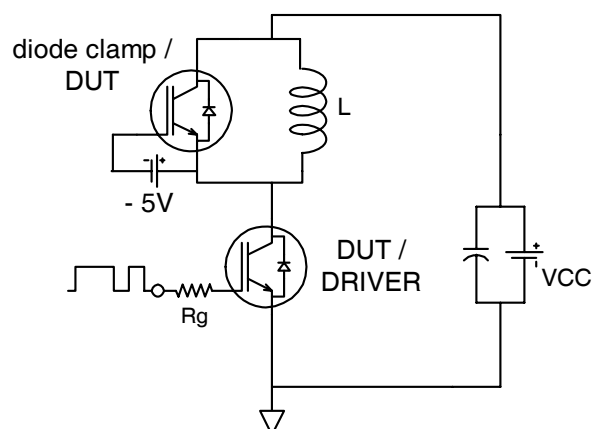
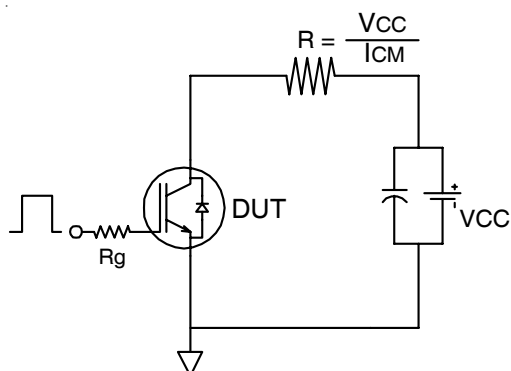


Fig. CT.5 - Resistive Load Circuit



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Fig. WF.1 - Typ. Turn-off Loss Waveform
@ $T_j=125^\circ\text{C}$ using Fig. CT.4

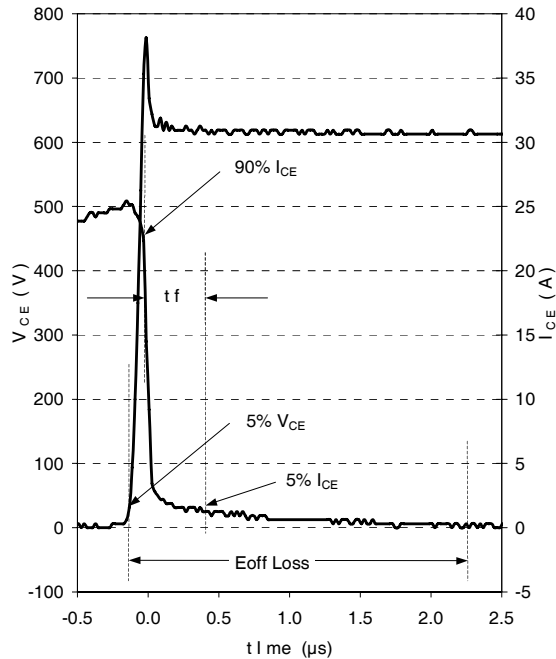


Fig. WF.2 - Typ. Turn-on Loss Waveform
@ $T_j=125^\circ\text{C}$ using Fig. CT.4

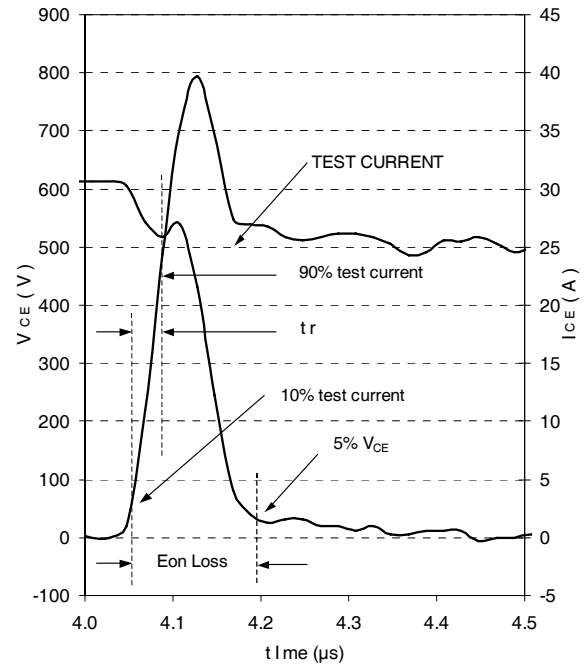


Fig. WF.3 - Typ. Diode Recovery Waveform
@ $T_j=125^\circ\text{C}$ using Fig. CT.4

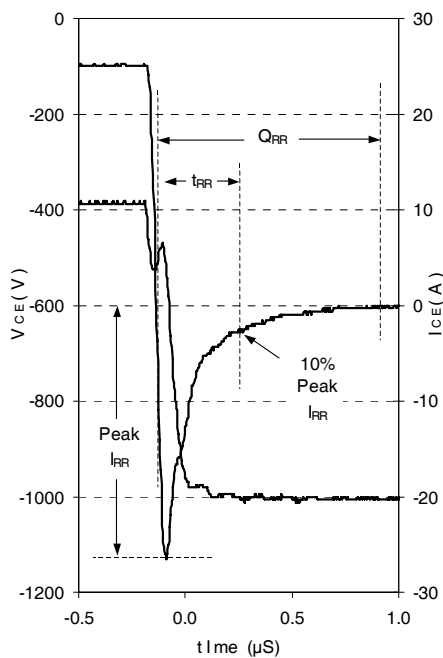
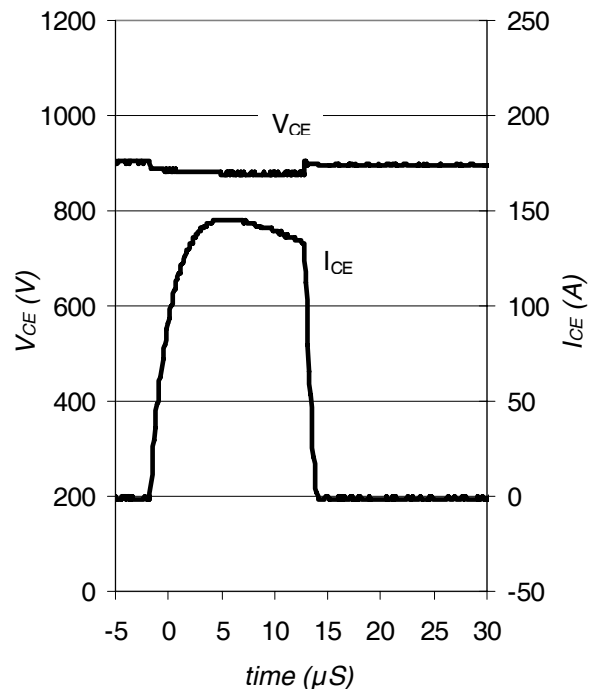
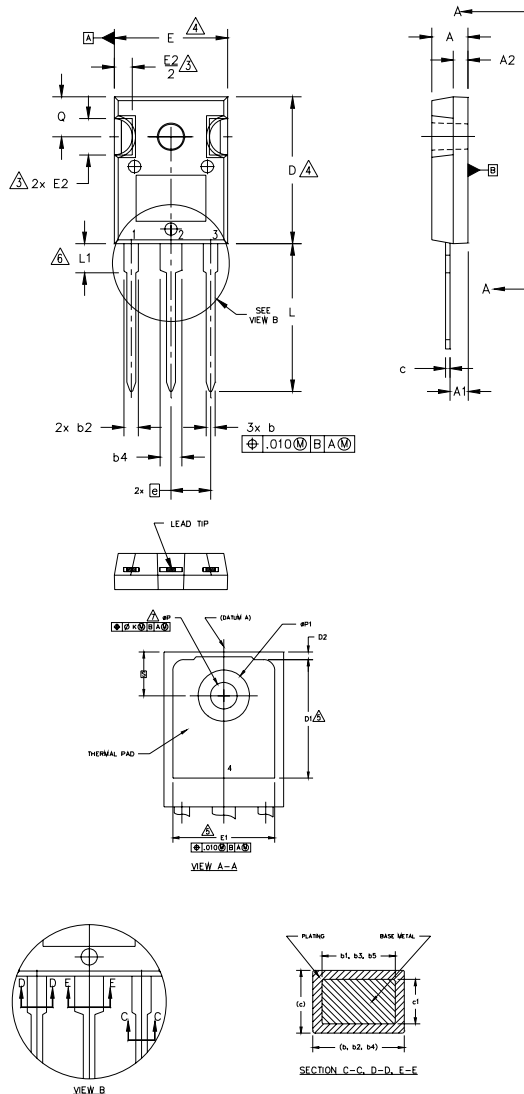


Fig. WF.4 - Typ. S.C. Waveform
@ $T_C=150^\circ\text{C}$ using Fig. CT.3



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TO-247AD Package Outline (Dimensions are shown in millimeters (inches))



- NOTES:
1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M 1994.
 2. DIMENSIONS ARE SHOWN IN INCHES.
 3. CONTOUR OF SLOT OPTIONAL.
 4. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
 5. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS D1 & E1.
 6. LEAD FINISH UNCONTROLLED IN L1.
 7. ØP TO HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM HOLE DIAMETER OF .154 INCH.
 8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-247AD.

SYMBOL	DIMENSIONS				NOTE
	INCHES		MILLIMETERS		
	MIN.	MAX.	MIN.	MAX.	
A	.183	.209	4.65	5.31	
A1	.087	.102	2.21	2.59	
A2	.059	.098	1.50	2.49	
b	.039	.055	0.99	1.40	
b1	.039	.053	0.99	1.35	
b2	.065	.094	1.65	2.39	
b3	.065	.092	1.65	2.34	
b4	.102	.135	2.59	3.43	
b5	.102	.133	2.59	3.38	
c	.015	.035	0.38	0.89	
c1	.015	.033	0.38	0.84	
D	.776	.815	19.71	20.70	4
D1	.515	—	13.08	—	5
D2	.020	.053	0.51	1.35	
E	.602	.625	15.29	15.87	4
E1	.530	—	13.46	—	
E2	.178	.216	4.52	5.49	
e	.215 BSC		5.46 BSC		
Øk	.010		0.25		
L	.780	.827	19.57	21.00	
L1	.146	.169	3.71	4.29	
ØP	.140	.144	3.56	3.66	
Q	—	.291	—	7.39	
Q	.209	.224	5.31	5.69	
S	.217 BSC		5.51 BSC		

LEAD ASSIGNMENTS

HEXFET

1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

IGBTs, CoPACK

1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

DIODES

1. ANODE/OPEN
2. CATHODE
3. ANODE

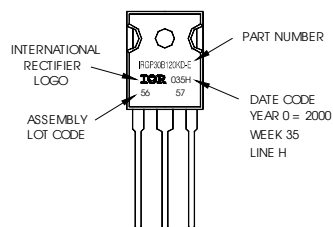
9. For the most current drawing please refer to IR website at <http://www.irf.com/package/pkigt.html>

TO-247AC package is not recommended for Surface Mount Application.

TO-247AD Part Marking Information

EXAMPLE: THIS IS AN IRGP30B120KD-E
WITH ASSEMBLY
LOT CODE 5657
ASSEMBLED ON WW 35, 2000
IN THE ASSEMBLY LINE "H"

Note: "P" in assembly line position
indicates "Lead-Free"



International
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157, 61350 Bad Homburg Tel: ++ 49 6172 96590

IR ITALY: Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 11 451 0111

IR JAPAN: K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo Japan 171 Tel: 81 3 3983 0086

IR SOUTHEAST ASIA: 1 Kim Seng Promenade, Great World City West Tower, 13-11, Singapore 237994 Tel: ++ 65 838 4630

IR TAIWAN: 16 Fl. Suite D. 207, Sec. 2, Tun Haw South Road, Taipei, 10673, Taiwan Tel: 886-2-2377-9936

Data and specifications subject to change without notice. 9/07

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